DIAION[™] SMT200L

DIAION™ SMT200L is a mixed resin with strongly acidic cation exchange resin, DIAION™ SKT20L, and strongly basic anion exchange resin, DIAION™ SAT20L. It is used for non-regenerable mixed bed for semiconductor ultrapure water.

Product

DIAION [™] SMT200L	Grade Name
Mixed	Туре
Styrene-DVB, Gel	Matrix
Sulfonic acid / Type I (trimethyl ammonium groups)	Functional Group
H ⁺ / OH ⁻	Ionic Form
1/1	Chemical Equivalent Ratio

Specification

Component			Mixed resin
Resistivity after 12 hours	MΩ·cm		18.1 min.
ΔTOC after 12 hours	ppb		1.0 max.
Component		Cation exchange resin	Anion exchange resin
		DIAION [™] SKT20L	DIAION [™] SAT20L
Color and Shape	-	Brown Translucent Beads	Light Yellow Translucent Beads
Salt Splitting Capacity	meq/mL	1.7 min.	0.9 min.
Water Content	%	50 - 60	62 - 72
Particle Size Distribution on 1180 μm	%	5 max.	5 max.
Particle Size Distribution thr. 425 μm	%	1 max.	1 max.
Effective Size	mm	0.45 min.	0.45 min.
Uniformity Coefficient	-	1.6 max.	1.6 max.
Ionic Form Conversion (H ⁺)	eq%	99.9 min.	-
Ionic Form Conversion (OH ⁻)	eq%	-	90 min.
Ionic Form Conversion (CI ⁻)	eq%	-	1 max.
Metal Content (Na)	ppb/dry-g	1000 max.	1000 max.
Metal Content (Ca)	ppb/dry-g	1000 max.	1000 max.
Metal Content (Fe)	ppb/dry-g	1000 max.	1000 max.
Metal Content (Zn)	ppb/dry-g	1000 max.	1000 max.
ΔTOC after 12 hours	ppb	5.0 max.	1.0 max.
Resistivity after 12 hours	$M\Omega$ ·cm	16 min.	18.1 min.

Typical Properties

Mixed resin			Component
710		g/L	Shipping Density
Anion exchange resin	Cation exchange resin		Component
DIAION [™] SAT20L	DIAION [™] SKT20L		
720	710	μm	Mean Particle Size
1.07	1.20	g/mL	Particle Density
-	9	%	Total Swelling (Na ⁺ to H ⁺)
24	-	%	Total Swelling (Cl to OH)

Recommended Operating Conditions

Maximum Operating Temperature	°C	60
Operating pH Range		0 - 14
Minimum Bed Depth	mm	800
Service Flow Rate	m/h	10 - 60







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Hydraulic Characteristics

The approximate pressure drop at various temperatures and flow rates for each meter of bed depth of $\mathsf{DIAION}^\mathsf{TM}$ SMT200L resin in normal down flow operation is shown in the graphs below.

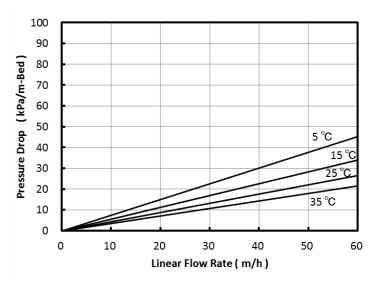


Fig. 1 Pressure Drop of SMT200L





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Rinse Performance

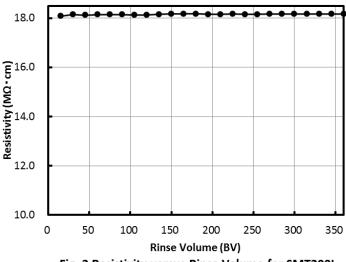


Fig. 2 Resistivity versus Rinse Volume for SMT200L Flow rate: SV 30 (15 L/hr), Resin volume: 500 mL-R

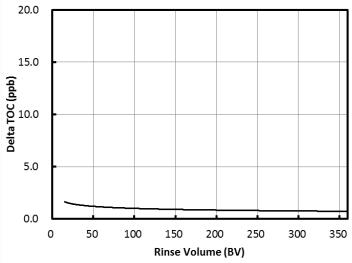


Fig. 3 Delta TOC versus Rinse Volume for SMT200L Flow rate : SV 30 (15 L/hr), Resin volume : 500 mL-R

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